



Form Type	Distribute	Version	2.0	Ref	IPC 1752A	Sectionals	Manufacturing Info/ Material Info	Subsectionals	D, A																									
Supplier Information																																		
Company Name	TE Connectivity	Request Document ID		Contact Name	CC WU	Contact Title	Product Compliance Engineer																											
Company Unique ID	TE Connectivity	Response Date	2015-06-22	Contact Email	cc.wu@tycoelectronics.com																													
Contact Phone Number		021-33259321																																
Legal Statement																																		
Supplier Acceptance	true																																	
Legal Statement																																		
The information provided in this document is based upon reasonable inquiry of our suppliers. This information is subject to change. This information does not in any way modify existing purchase specifications or existing contractual or other agreements terms between TE Connectivity (or its affiliated companies) and its customers.																																		
Product																																		
Manufacturer Item number	350742-4	Amount	5.64215725	Version	-	Identity																												
Manufacturer Item Name	09P UMNL PIN HDR ASSY 94VO LF	Weight Uom	g	Mfr Site		Authority																												
Date		UOM	Each																															
EUROHS-0508	Product(s) meets EU RoHS requirement without any exemptions																																	
ChinaRoHS-0508	Product(s) is eligible for marking with the e code under China's Measures for Administration of the control of pollution by Electronic Information Products																																	
EUREACH-1214	REACH Candidate Substances of Very High Concern ARE NOT Yet Reviewed																																	
Manufacturing Information																																		
J-STD-020 MSL Rating		Max Total a Wave Time		Ramp Rate		Wave Additional Info																												
Classification Temp		Max Wave Solder Time	10.0	Ramp Down Rate		Psi Rating Reflow																												
Max Time Within 5		Psi Rating Wave		Package Designator		Size	0.0																											
Time Above 217		Reflow Additional Info		Preheat Max Temp		Terminal Base Alloy	NAC																											
Preheat Duration		bulk Solder Termination	NAC	Nbr or Reflow Cycles		Terminal Plating	NAC																											
Preheat Min Temp		Nbr of Instances	0	Component Temp Spike		Shape	NAC																											
Product Disclosure																																		
Sub-Item/Material/Substance	Level	Name	Substance Category	Substance CAS	Substance Concentration	Quantity	Mass per Unit	UOM	Exemption																									
Sub-Item	1	UMNL PIN, PC HDR TIN				9.0	0.21412858	g																										
Material	2	Tin Plate				9.0	0.00156025	g																										
Substance	3	Lead	Lead/Lead Compounds	7439-92-1	0.0999	9.0	1.558686E-6	g																										
Substance	3	Tin	Supplier	7440-31-5	99.9001	9.0	0.00155869	g																										
Material	2	Phos Bronze				9.0	0.2108	g																										
Substance	3	Copper	Supplier	7440-50-8	94.6835	9.0	0.19959282	g																										
Substance	3	Manganese	Supplier	7439-96-5	0.02	9.0	4.216E-5	g																										
Substance	3	Chromium	Supplier	7440-47-3	0.01	9.0	2.108E-5	g																										
Substance	3	Tin	Supplier	7440-31-5	4.5	9.0	0.009486	g																										
Substance	3	Arsenic	Supplier	7440-38-2	0.015	9.0	3.162E-5	g																										
Substance	3	Iron	Supplier	7439-89-6	0.1	9.0	2.108E-4	g																										
Substance	3	Antimony	Supplier	7440-36-0	0.01	9.0	2.108E-5	g																										
Substance	3	Beryllium	Supplier	7440-41-7	0.0010	9.0	2.108E-6	g																										
Substance	3	Zinc	Supplier	7440-66-6	0.3	9.0	6.324E-4	g																										
Substance	3	Phosphorus	Supplier	7723-14-0	0.1	9.0	2.108E-4	g																										
Substance	3	Cobalt	Supplier	7440-48-4	0.1	9.0	2.108E-4	g																										
Substance	3	Cadmium	Cadmium/Cadmium Compounds	7440-43-9	0.01	9.0	2.108E-5	g																										
Substance	3	Lead	Lead/Lead Compounds	7439-92-1	0.05	9.0	1.054E-4	g																										
Substance	3	Nickel	Nickel	7440-02-0	0.1	9.0	2.108E-4	g																										
Substance	3	Mercury	Mercury/Mercury Compounds	7439-97-6	5.0E-4	9.0	1.054E-6	g																										
Material	2	Nickel Plate				9.0	0.00128813	g																										

Substance	3	Contains No Reportable TE5081-2 Substances	Supplier	TE5081-2-1212	0.2	9.0	2.576252E-6	g	
Substance	3	Lead	Lead/Lead Compounds	7439-92-1	0.1	9.0	1.288126E-6	g	
Substance	3	Nickel	Nickel	7440-02-0	99.7	9.0	0.00128426	g	
Material	2	Gold Plate				9.0	4.8021E-4	g	
Substance	3	Gold	Supplier	7440-57-5	99.7	9.0	4.7877E-4	g	
Substance	3	Contains No Reportable TE5081-2 Substances	Supplier	TE5081-2-0909	0.3	9.0	1.440633E-6	g	
Sub-Item	1	09P UMNL HDR HSG				1.0	3.715	g	
Material	2	PA				1.0	3.715	g	
Substance	3	Water	Supplier	7732-18-5	0.3262	1.0	0.01211833	g	
Substance	3	2H-Azepin-2-one, hexahydro-	Supplier	105-60-2	0.4637	1.0	0.01722645	g	
Substance	3	Siloxanes and Silicones, di-Me	Supplier	63148-62-9	3.0E-4	1.0	1.1145E-5	g	
Substance	3	Poly[imino(1,6-dioxo-1,6-hexanediyl)imino-1,6-hexanediyl]	Supplier	32131-17-2	0.9451	1.0	0.03511047	g	
Substance	3	Benzenepropionamide, N,N-1,6-hexanediylbis[3,5-bis(1,1-dimethylethyl)-4-hydroxy-	Supplier	23128-74-7	0.4004	1.0	0.01487486	g	
Substance	3	1,2-Ethanediamine	Supplier	107-15-3	0.0033	1.0	1.226E-4	g	
Substance	3	Phosphoric acid, sodium salt, hydrate (1:2:12)	Supplier	10039-32-4	0.025	1.0	9.2875E-4	g	
Substance	3	Octadecanoic acid, calcium salt (2:1)	Supplier	1592-23-0	0.2012	1.0	0.00747458	g	
Substance	3	Octadecanamide, N,N-1,2-ethanediylbis-	Supplier	110-30-5	0.1901	1.0	0.00706221	g	
Substance	3	1,3,5-Triazine-2,4,6-(1H,3H,5H)-trione, compd. with 1,3,5-triazine-2,4,6-triamine (1:1)	Supplier	37640-57-6	9.0717	1.0	0.33701366	g	
Substance	3	Hexanedioic acid, polymer with hexahydro-2H-azepin-2-one and 1,6-hexanediamine	Supplier	24993-04-2	88.373	1.0	3.28305695	g	